

Product data sheet

Specifications



redundant processor kit, Modicon
M580, 16MB, 61 Ethernet devices,
16 Remote I/O racks (X80 &
Quantum I/O)

BMEH584040K

Main

Range of product	Modicon M580
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Complementary

Marking	CE
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Environment

Vibration resistance	3 gn
Shock resistance	30 gn
Ambient air temperature for operation	-25...60 °C
Ambient air temperature for storage	-40...85 °C
Operating altitude	0...2000 m 2000...5000 m with derating factor
Relative humidity	5...95 % at 55 °C without condensation
IP degree of protection	IP20
Directives	2014/35/EU - low voltage directive 2014/30/EU - electromagnetic compatibility
Product certifications	CE UL CSA RCM EAC Merchant Navy
Standards	IEC 61131-2 IEC 61010-2-201 UL 61010-2-201 CSA C22.2 No 61010-2-201 IACS E10 EN/IEC 61000-6-5, interface type 1 and type 2 EN/IEC 61850-3, location G
Environmental characteristic	Hazardous location class I division 2
Net weight	1.698 kg

Packing Units

Unit Type of Package 1	PCE
Number of Units in Package 1	1
Package 1 Height	15.000 cm
Package 1 Width	30.000 cm
Package 1 Length	40.000 cm

Disclaimer: This documentation is not intended as a substitute for and is not to be used for determining suitability or reliability of these products for specific user applications

Package 1 Weight	2.202 kg
Unit Type of Package 2	P06
Number of Units in Package 2	8
Package 2 Height	45.000 cm
Package 2 Width	60.000 cm
Package 2 Length	80.000 cm
Package 2 Weight	27.616 kg

Environmental Data

Schneider Electric aims to achieve Net Zero status by 2050 through supply chain partnerships, lower impact materials, and circularity via our ongoing “Use Better, Use Longer, Use Again” campaign to extend product lifetimes and recyclability.

[Environmental Data explained >](#)

[How we assess product sustainability >](#)

Environmental footprint	
Total lifecycle Carbon footprint	609
Environmental Disclosure	Product Environmental Profile

Use Better

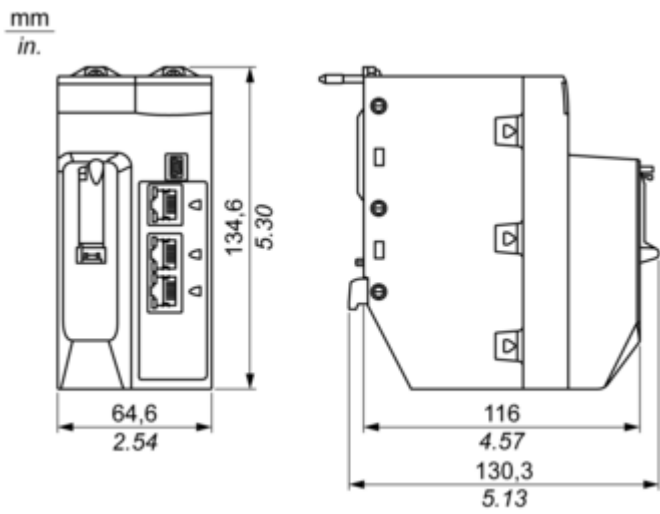
Materials and Substances	
Packaging made with recycled cardboard	Yes
Packaging without single use plastic	No
EU RoHS Directive	Pro-active compliance (Product out of EU RoHS legal scope)
SCIP Number	4eb70ab0-978b-4773-a441-0cc20d6144a1
REACH Regulation	REACH Declaration
California proposition 65	WARNING: This product can expose you to chemicals including: Lead and lead compounds, which is known to the State of California to cause cancer and birth defects or other reproductive harm. For more information go to www.P65Warnings.ca.gov

Use Again

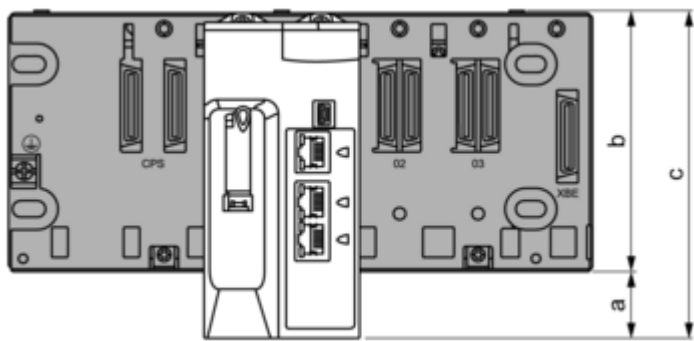
Repack and remanufacture	
End of life manual availability	End of Life Information
Take-back	No

Dimensions Drawings

CPU Module Only

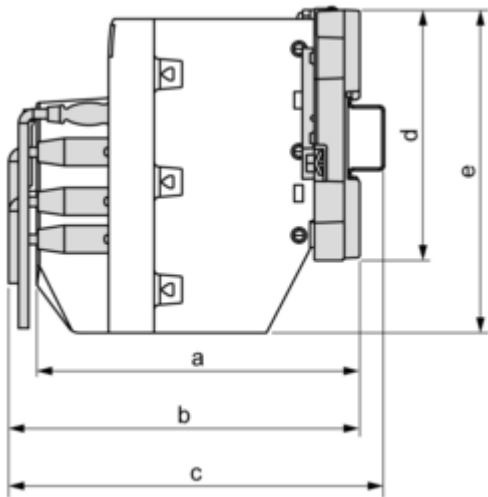


Modules Mounted on Racks



- a:** additional space below the rack to accommodate the height of the CPU. For an X Bus rack, the value is 30.9 mm (1.217 in.); for an Ethernet rack, the value is 29.49 mm (1.161 in.).
- b:** the height of the rack. For an X Bus rack, the height is 103.7 mm (4.083 in.); for an Ethernet rack, the height is 105.11 mm (4.138 in.).
- c:** the height of the main local rack, 134.6 mm (5.299 in.)

Modules and Cables Mounted in an Enclosure



- a: enclosure depth: 135 mm (5.315 in.)
- b: wiring + module depth: > 146 mm (5.748 in.)
- c: wiring + module + DIN rail depth: > 156 mm (6.142 in.)
- d: rack height: for an X Bus rack 103.7 mm (4.083 in.); for an Ethernet rack, 105.11 mm (4.138 in.)
- e: module height: 134.6 mm (5.299 in.)

Image of product / Alternate images

Alternative

